

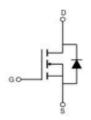


Feature

• 40V,10A

 $\begin{aligned} &\mathsf{R}_{\mathsf{DS}\;(\mathsf{ON})} <& 22\mathsf{m}\;\Omega\;@\mathsf{V}_{\mathsf{GS}} \text{=} 10\mathsf{V} \\ &\mathsf{R}_{\mathsf{DS}\;(\mathsf{ON})} <& 30\mathsf{m}\;\Omega\;@\mathsf{V}_{\mathsf{GS}} \text{=} 4.5\mathsf{V} \end{aligned}$

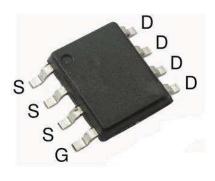
- Trench Power MOSFET
- Fast Switching
- Low on-resistance and maximum



Schematic Diagram

Application

- DC/DC Converter
- Load Switch for Portable Devices
- Battery Switch
- Halogen-free



SOP-8

Package Marking and Ordering Information

| Device Marking | Device | Device Package | Device Package Reel Size Tape width | | Quantity (PCS) | |
|----------------|-----------|----------------|-------------------------------------|---|----------------|--|
| 4013S | RM10N40S8 | SOP-8 | 13 inch | - | 4000 | |

ABSOLUTE MAXIMUM RATINGS (T₂=25℃ unless otherwise noted)

| Parameter | Symbol | Value | Unit |
|---|------------------|-----------|--------------|
| Drain-Source Voltage | V _{DS} | 40 | V |
| Gate-Source Voltage | V _{GS} | ±20 | V |
| Continuous Drain Current (T _a =25℃) | I D | 10 | А |
| Continuous Drain Current (T _a =100℃) | I D | 6.5 | А |
| Pulsed Drain Currenr (1) | I _{DM} | 40 | Α |
| Power Dissipation | P _D | 2 | W |
| Thermal Resistance from Junction to Ambient | Reja | 62.5 | °C/W |
| Junction Temperature | TJ | 150 | $^{\circ}$ |
| Storage Temperature | T _{STG} | -55~ +150 | $^{\circ}$ C |

MOSFET ELECTRICAL CHARACTERISTICS(T_a =25°C unless otherwise noted)

| Parameter | Symbol | Test Condition | Min | Type | Max | Unit |
|---|----------------------|--|-----|------|------|------|
| Static Characteristics | | | • | | | |
| Drain-source breakdown voltage | V _{(BR)DSS} | V _{GS} = 0V, I _D =250μA | 40 | - | - | V |
| Zero gate voltage drain current | I _{DSS} | V _{DS} =40V, V _{GS} = 0V | - | _ | 1 | μA |
| Gate-body leakage current | lgss | $V_{GS} = \pm 20V$, $V_{DS} = 0V$ | - | - | ±100 | nA |
| Gate threshold voltage ⁽²⁾ | $V_{GS(th)}$ | V _{DS} =V _{GS} , I _D =250μA | 1 | 1.5 | 2.5 | V |
| Drain-source on-resistance ⁽²⁾ | | V _{GS} =10V, I _D =10A | - | 17 | 22 | mΩ |
| Drain-source on-resistance(2) | R _{DS(on)} | V _{GS} =4.5V, I _D =6A | - | 22 | 30 | |
| Dynamic characteristics | | | | | | |
| Input Capacitance | Ciss | V _{DS} =20V, V _{GS} =0V, f =1MHz | - | 1050 | - | pF |
| Output Capacitance | Coss | | - | 84 | - | |
| Reverse Transfer Capacitance | Crss | | - | 72 | - | |
| Switching characteristics | | • | | | | |
| Turn-on delay time | t _{d(on)} | | - | 11 | - | |
| Turn-on rise time | tr | V_{DD} =20V, R_L =1.5 Ω V_{GS} =10V, R_G =3 Ω | - | 13 | - | ns |
| Turn-off delay time | t _{d(off)} | | - | 36 | - | |
| Turn-off fall time | t _f | | - | 9 | - | |
| Total Gate Charge | Qg | VDS=20V, ID=5A, | - | 11 | - | nC |
| Gate-Source Charge | Qgs | | - | 1.9 | - | |
| Gate-Drain Charge | Qgd | - VGS=10V | - | 2.2 | - | |
| Source-Drain Diode characteristics | | • | · | • | | |
| Diode Forward voltage(2) | V _{DS} | V _{GS} =0V, I _S =10A | - | - | 1.2 | V |
| Diode Forward current ⁽³⁾ | Is | | - | - | 40 | Α |

Notes:

- 1. Repetitive Rating: pulse width limited by maximum junction temperature
- 2. Pulse Test: pulse width≤300µs, duty cycle≤2%
- 3. Surface Mounted on FR4 Board,t≤10 sec



RATING AND CHARACTERISTICS CURVES (RM10N40S8)

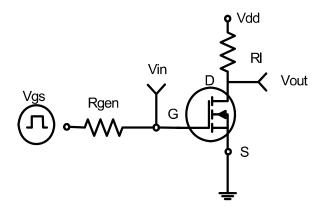


Figure 1:Switching Test Circuit

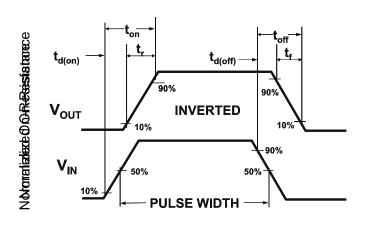


Figure 2:Switching Waveforms

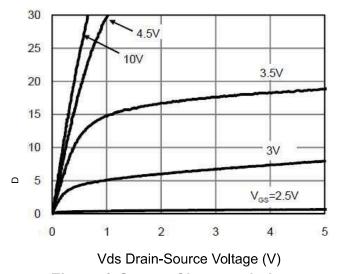


Figure 3 Output Characteristics

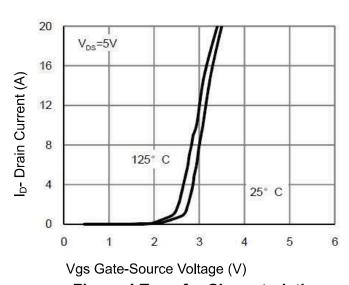


Figure 4 Transfer Characteristics

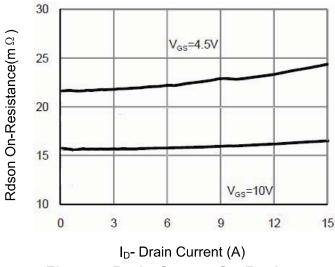


Figure 5 Drain-Source On-Resistance

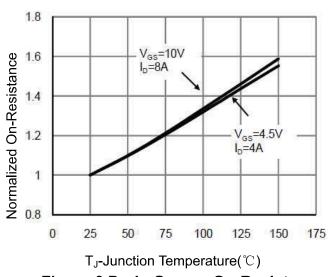
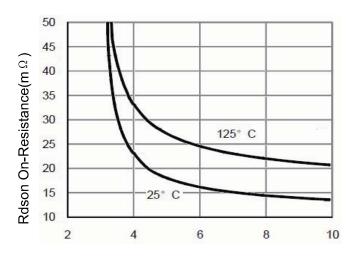


Figure 6 Drain-Source On-Resistance

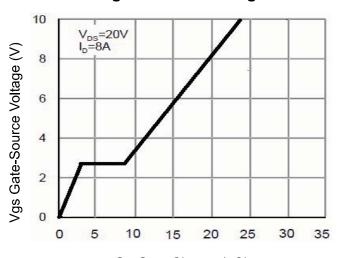


RATING AND CHARACTERISTICS CURVES (RM10N40S8)



Vgs Gate-Source Voltage (V)

Figure 7 Rdson vs Vgs



Qg Gate Charge (nC)

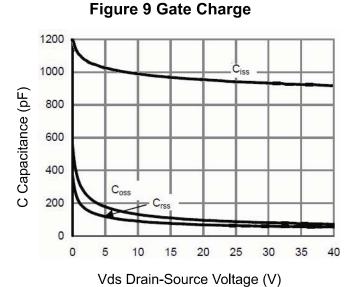
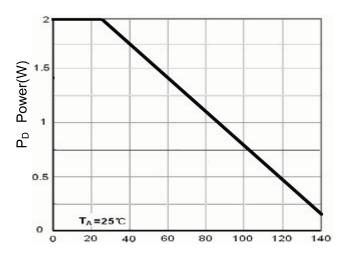
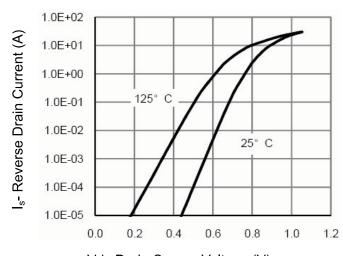


Figure 11 Capacitance vs Vds



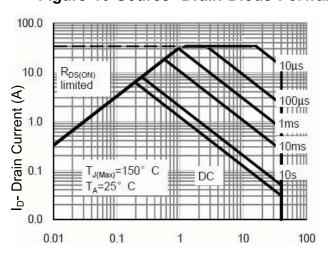
T_J-Junction Temperature(°C)

Figure 8 Power Dissipation



Vds Drain-Source Voltage (V)

Figure 10 Source- Drain Diode Forward

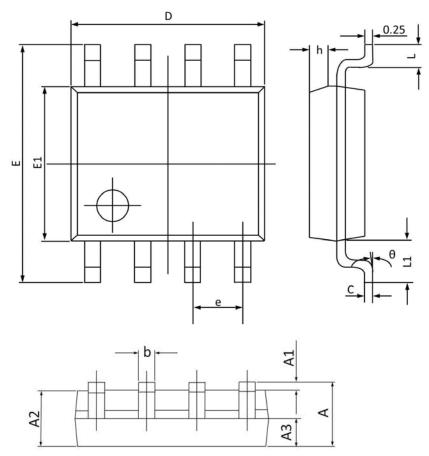


Vds Drain-Source Voltage (V)

Figure 12 Safe Operation Area



SOP8 PACKAGE INFORMATION



| Crymb al | Dimensions In Millimeters | | Dimensions In Inches | | |
|------------|----------------------------------|-------|-----------------------------|-------|--|
| Symbol | Min | Max | Min | Max | |
| A | 1.350 | 1.750 | 0.053 | 0.068 | |
| A1 | 0.100 | 0.250 | 0.004 | 0.009 | |
| A2 | 1.300 | 1.500 | 0.052 | 0.059 | |
| A3 | 0.600 | 0.700 | 0.024 | 0.027 | |
| b | 0.390 | 0.480 | 0.016 | 0.018 | |
| c | 0.210 | 0.260 | 0.009 | 0.010 | |
| D | 4.700 | 5.100 | 0.186 | 0.200 | |
| E | 5.800 | 6.200 | 0.229 | 0.244 | |
| E 1 | 3.700 | 4.100 | 0.146 | 0.161 | |
| e | 1.270(BSC) | | 0.050(BSC) | | |
| h | 0.250 | 0.500 | 0.010 | 0.019 | |
| L | 0.500 | 0.800 | 0.019 | 0.031 | |
| L1 | 1.050(BSC) | | 0.041(BSC) | | |
| θ | 0° | 8° | 0° | 8° | |



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